



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ball et al.

Serial No.: 09/736,795

Filed: December 14, 2000

For: METHOD OF DISPOSING
CONDUCTIVE BUMPS ONTO A
SEMICONDUCTOR DEVICE

Confirmation No.: 6757

Examiner: E. Pert

Group Art Unit: 2829

Attorney Docket No.: 2269-3817.1US
(97-1350.01/US)

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Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification begin on page 3 of this paper.

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Abstract appear on page 7 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 8 of this paper.

Remarks begin on page 14 of this paper.